# onsemi

# **MOSFET** - Power, Single N-Channel, TOLL 80 V, 0.79 mΩ, 457 A NTBLS0D8N08X

<b>-</b>	
Features	5

- Low Q<sub>RR</sub>, Soft Recovery Body Diode
- Low R<sub>DS(on)</sub> to Minimize Conduction Losses
- Low Q<sub>G</sub> and Capacitance to Minimize Driver Losses
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

#### **Typical Applications**

- Synchronous Rectification (SR) in DC-DC and AC-DC
- Primary Switch in Isolated DC-DC Converter
- Motor Drives

# **MAXIMUM RATINGS** (T<sub>J</sub> = $25^{\circ}$ C unless otherwise noted)

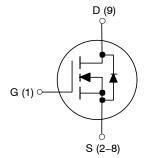
Parameter		Symbol	Value	Unit
Drain-to-Source Voltage		V <sub>DSS</sub>	80	V
Gate-to-Source Voltage	Gate-to-Source Voltage		±20	V
Continuous Drain Current	Continuous Drain Current $T_{C} = 25^{\circ}C$		457	А
	T <sub>C</sub> = 100°C		323	
Power Dissipation	T <sub>C</sub> = 25°C	PD	325	W
Pulsed Drain Current	T <sub>C</sub> = 25°C,	I <sub>DM</sub>	1629	А
Pulsed Source Current (Body Diode)	t <sub>p</sub> = 100 μs	I <sub>SM</sub>	1629	
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	–55 to +175	°C
Source Current (Body Diode)		۱ <sub>S</sub>	547	А
Single Pulse Avalanche Energy (I <sub>PK</sub> = 103 A)		E <sub>AS</sub>	530	mJ
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)		ΤL	260	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

- 1. The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.
- Actual continuous current will be limited by thermal & electromechanical application board design.
- 3.  $E_{AS}$  of 530 mJ is based on started  $T_J$  = 25°C,  $I_{AS}$  = 103 A,  $V_{DD}$  = 64 V,  $V_{GS}$  = 10 V, 100% avalanche tested.

V <sub>(BR)DSS</sub>	R <sub>DS(ON)</sub> MAX	I <sub>D</sub> MAX
80 V	0.79 mΩ @ 10 V	457 A

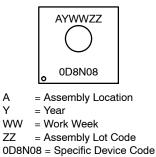
## **N-CHANNEL MOSFET**





H-PSOF8L CASE 100CU

#### MARKING DIAGRAM



#### **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>
NTBLS0D8N08X	H-PSOF8L (Pb-Free)	2000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

## **Table 1. THERMAL CHARACTERISTICS**

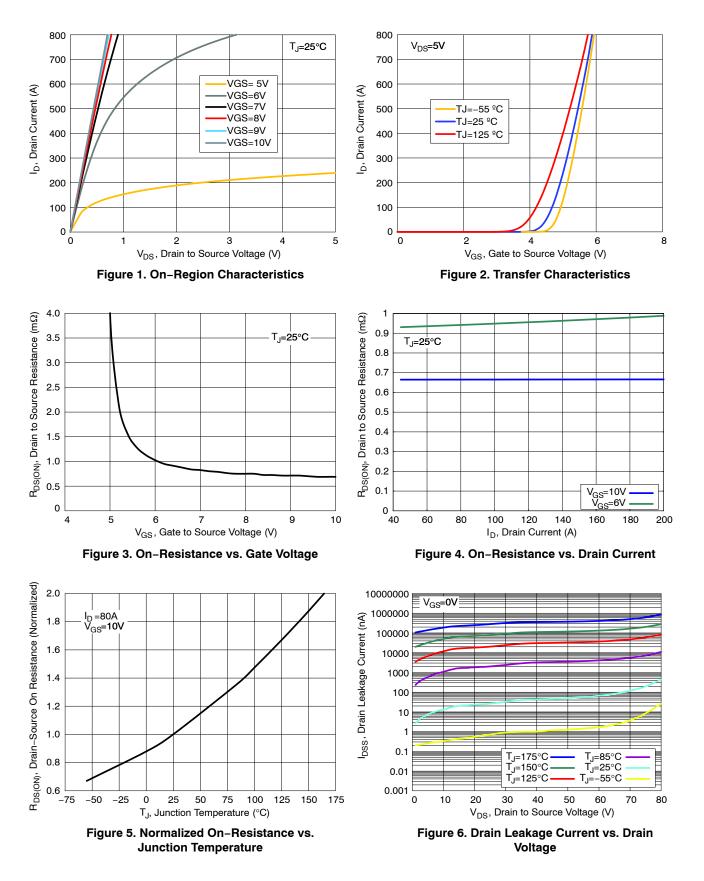
Parameter		Value	Unit
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	0.46	°C/W
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	43	

# Table 2. ELECTRICAL CHARACTERISTICS (T<sub>J</sub> = 25°C unless otherwise noted) Parameter Symbol Test Condition

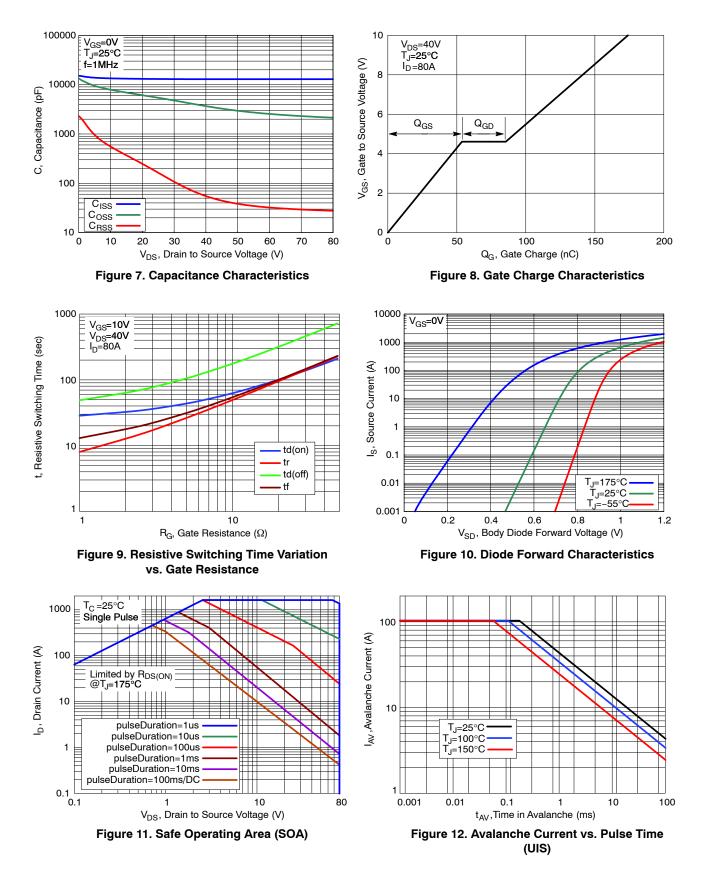
Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
OFF CHARACTERISTICS	•	•				
Drain-to-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	$V_{GS}$ = 0 V, $I_D$ = 1 mA, $T_J$ = 25°C	80			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	$\Delta V_{(BR)DSS}/ \Delta T_J$	$I_D = 1$ mA, Referenced to 25°C		35.5		mV/°C
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{DS} = 80 \text{ V}, \text{ T}_{\text{J}} = 25^{\circ}\text{C}$			2	μA
		$V_{DS} = 80 \text{ V}, \text{ T}_{\text{J}} = 125^{\circ}\text{C}$			250	1
Gate-to-Source Leakage Current	I <sub>GSS</sub>	$V_{GS}$ = 20 V, $V_{DS}$ = 0 V			100	nA
ON CHARACTERISTICS						
Drain-to-Source On Resistance	R <sub>DS(on)</sub>	$V_{GS}$ = 10 V, I <sub>D</sub> = 80 A, T <sub>J</sub> = 25°C		0.69	0.79	mΩ
		$V_{GS}$ = 6 V, I <sub>D</sub> = 71 A, T <sub>J</sub> = 25°C		1	1.26	1
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{GS}$ = $V_{DS}$ , $I_D$ = 720 $\mu$ A, $T_J$ = 25°C	2.4		3.6	V
Gate Threshold Voltage Temperature Coefficient	${\Delta V_{GS(th)} / \over \Delta T_J}$	$V_{GS}$ = $V_{DS}$ , $I_D$ = 720 $\mu$ A		-7.95		mV/°C
Forward Transconductance	9 <sub>FS</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 80 A		485		S
CHARGES, CAPACITANCES & GATE RE	SISTANCE					
Input Capacitance	C <sub>iss</sub>	$V_{DS}$ = 40 V, $V_{GS}$ = 0 V, f = 1 MHz		12920		pF
Output Capacitance	C <sub>oss</sub>			3670		
Reverse Transfer Capacitance	C <sub>rss</sub>			55		
Output Charge	Q <sub>oss</sub>			262		nC
Total Gate Charge	Q <sub>G(tot)</sub>	$V_{DD}$ = 40 V, $I_D$ = 80 A, $V_{GS}$ = 6 V		109		]
		$V_{DD}$ = 40 V, I <sub>D</sub> = 80 A, V <sub>GS</sub> = 10 V		174		1
Threshold Gate Charge	Q <sub>G(th)</sub>			34		
Gate-to-Source Charge	Q <sub>gs</sub>			54		
Gate-to-Drain Charge	Q <sub>gd</sub>			32		
Gate Plateau Voltage	V <sub>gp</sub>			4.6		V
Gate Resistance	R <sub>g</sub>	f = 1 MHz		0.5		Ω
SWITCHING CHARACTERISTICS						
Turn-On Delay Time	t <sub>d(on)</sub>	Resistive Load, $V_{GS} = 0/10 V$ ,		34		ns
Rise Time	t <sub>r</sub>	$V_{DD}$ = 40 V, $I_D$ = 80 Å, $R_G$ = 2.5 $\Omega$		15		1
Turn-Off Delay Time	t <sub>d(off)</sub>			70		7
Fall Time	t <sub>f</sub>			20		
SOURCE-TO-DRAIN DIODE CHARACTE	ERISTICS					
Forward Diode Voltage	V <sub>SD</sub>	$I_{S}$ = 80 A, $V_{GS}$ = 0 V, $T_{J}$ = 25°C		0.8		V
		$I_{S}$ = 80 A, $V_{GS}$ = 0 V, $T_{J}$ = 125°C		0.66		1
Reverse Recovery Time	t <sub>rr</sub>	$V_{GS} = 0 V, I_{S} = 80 A$		48		ns
Charge Time	ta	dl/dt = 1000 A/μs, V <sub>DD</sub> = 40 V		27		1
Discharge Time	t <sub>b</sub>	-		49		1
Reverse Recovery Charge	Q <sub>rr</sub>			464		nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

# **TYPICAL CHARACTERISTICS**



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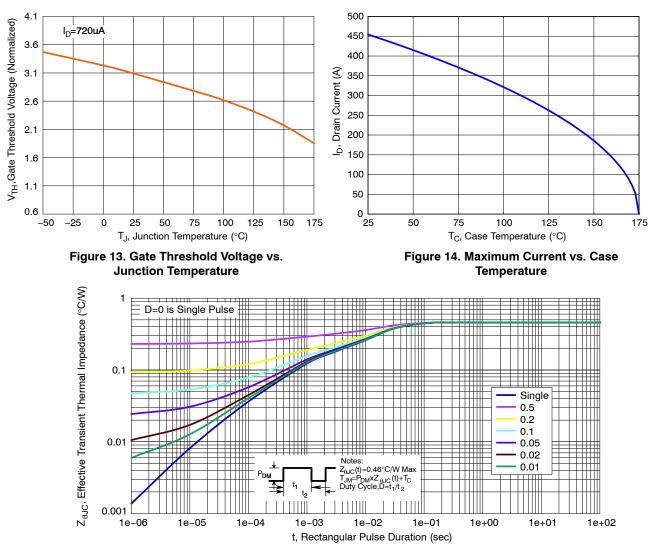
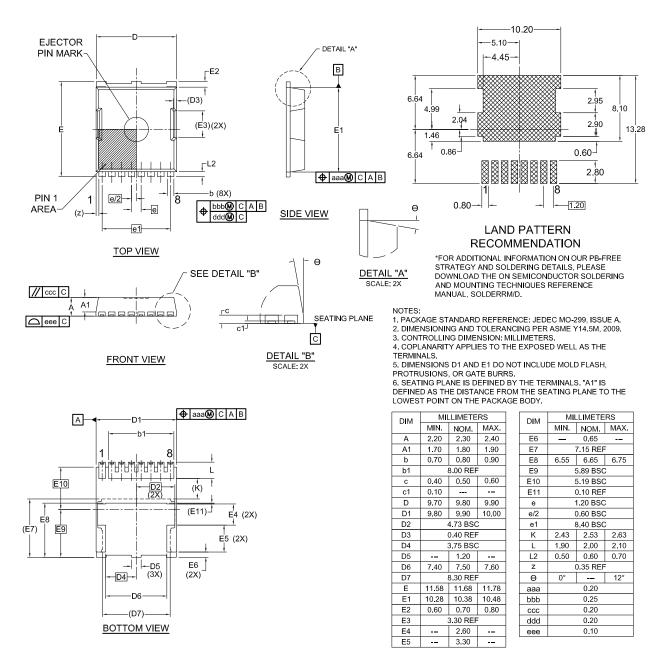


Figure 15. Transient Thermal Response

## PACKAGE DIMENSIONS

H-PSOF8L 11.68x9.80 CASE 100CU ISSUE B



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